#### 捷多邦,专业PCB打样**ISN54LV240A**共**S**N74LV240A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCLS384H - SEPTEMBER 1997 - REVISED APRIL 2005

- 2-V to 5.5-V V<sub>CC</sub> Operation
- Max t<sub>pd</sub> of 6.5 ns at 5 V
- Typical V<sub>OLP</sub> (Output Ground Bounce)
  <0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)
  >2.3 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Support Mixed-Mode Voltage Operation on All Ports
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

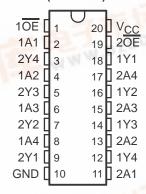
#### description/ordering information

These octal buffers/drivers are designed for 2-V to 5.5-V V<sub>CC</sub> operation.

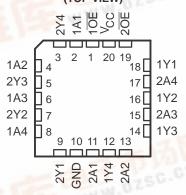
The 'LV240A devices are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

These devices are organized as two 4-bit buffers/line drivers with separate output-enable  $(\overline{OE})$  inputs. When  $\overline{OE}$  is low, the device passes data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

SN54LV240A . . . J OR W PACKAGE SN74LV240A . . . DB, DGV, DW, NS, OR PW PACKAGE (TOP VIEW)



## SN54LV240A ... FK PACKAGE (TOP VIEW)



#### ORDERING INFORMATION

TA NIN	PACK	AGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
1	2010 514	Tube of 25	SN74LV240ADW	11/0404
	SOIC - DW	Reel of 2000	SN74LV240ADWR	LV240A
	SOP - NS	Reel of 2000	SN74LV240ANSR	74LV240A
4000 +- 0500	SSOP – DB Reel of 2000 SN74LV		SN74LV240ADBR	LV240A
−40°C to 85°C		Tube of 70	SN74LV240APW	MAIM MY
	TSSOP - PW	Reel of 2000	SN74LV240APWR	LV240A
	_ 17.17	Reel of 250	SN74LV240APWT	
111	TVSOP - DGV	Reel of 2000	SN74LV240ADGVR	LV240A
-EE	CDIP – J	Tube of 20	SNJ54LV240AJ	SNJ54LV240AJ
-55°C to 125°C	CFP – W	Tube of 85	SNJ54LV240AW	SNJ54LV240AW
1-4	LCCC – FK	Tube of 55	SNJ54LV240AFK	SNJ54LV240AFK

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



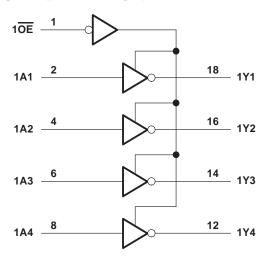
#### description/ordering information (continued)

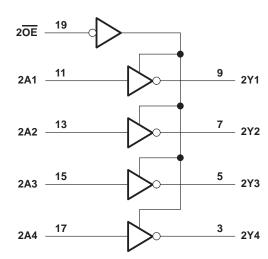
To ensure the high-impedance state during power up or power down,  $\overline{\text{OE}}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

FUNCTION TABLE (each buffer)

INP	JTS	OUTPUT			
OE	Α	Υ			
L	Н	L			
L	L	Н			
Н	Χ	Z			

#### logic diagram (positive logic)







#### SN54LV240A, SN74LV240A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Cumply valtage region \/		051/4071/
Supply voltage range, V <sub>CC</sub>		
Input voltage range, V <sub>I</sub> (see Note 1)		
Voltage range applied to any output in the high		
or power-off state, VO (see Note 1)		
Output voltage range applied in the high or low	v state, V <sub>O</sub> (see Notes 1 and 2)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, $I_{IK}$ ( $V_I < 0$ )		–20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)		–50 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )		±35 mA
Continuous current through V <sub>CC</sub> or GND		±70 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 3)	: DB package	70°C/W
	DGV package	92°C/W
	DW package	58°C/W
	NS package	60°C/W
	PW package	83°C/W
Storage temperature range, T <sub>stg</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 5.5 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.



#### SN54LV240A, SN74LV240A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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#### recommended operating conditions (see Note 4)

			SN54L	V240A	SN74L	V240A	
			MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage		2	5.5	2	5.5	V
		V <sub>CC</sub> = 2 V	1.5		1.5		
.,	18.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	V <sub>CC</sub> × 0.7		V <sub>CC</sub> × 0.7		
VIH	High-level input voltage	V <sub>CC</sub> = 3 V to 3.6 V	V <sub>CC</sub> ×0.7		V <sub>CC</sub> ×0.7		V
		V <sub>CC</sub> = 4.5 V to 5.5 V	V <sub>CC</sub> ×0.7		V <sub>CC</sub> ×0.7		
		V <sub>CC</sub> = 2 V		0.5		0.5	
.,		V <sub>CC</sub> = 2.3 V to 2.7 V		V <sub>CC</sub> ×0.3		V <sub>CC</sub> × 0.3	
VIL	Low-level input voltage	V <sub>CC</sub> = 3 V to 3.6 V		V <sub>CC</sub> ×0.3		V <sub>CC</sub> × 0.3	V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		V <sub>CC</sub> ×0.3		$V_{CC} \times 0.3$	
٧ <sub>I</sub>	Input voltage		0	5.5	0	5.5	V
.,	0 "	High or low state	0	<sup>4</sup> √V <sub>CC</sub>	0	Vcc	
VO	Output voltage	3-state	0 ,	5.5	0	5.5	V
		V <sub>CC</sub> = 2 V	2	-50		-50	μΑ
١.	LPab lavel autout aumant	V <sub>CC</sub> = 2.3 V to 2.7 V	20	-2		-2	
ЮН	High-level output current	V <sub>CC</sub> = 3 V to 3.6 V	Q	-8		-8	mA
		V <sub>CC</sub> = 4.5 V to 5.5 V		-16		-16	
		V <sub>CC</sub> = 2 V		50		50	μΑ
١.	Law law law and a summer	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2		2	
lOL	Low-level output current	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		8		8	mA
		V <sub>CC</sub> = 4.5 V to 5.5 V		16		16	
		V <sub>CC</sub> = 2.3 V to 2.7 V		200		200	
Δt/Δν	Input transition rise or fall rate	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		100		100	ns/V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		20		20	
TA	Operating free-air temperature	·	-55	125	-40	85	°C

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER	TEST CONDITIONS	.,	SN5	SN54LV240A			SN74LV240A		
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
	I <sub>OH</sub> = -50 μA	2 V to 5.5 V	V <sub>CC</sub> -0.1			V <sub>CC</sub> -0.1			
V	$I_{OH} = -2 \text{ mA}$	2.3 V	2			2			.,
VOH	$I_{OH} = -8 \text{ mA}$	3 V	2.48			2.48			V
	$I_{OH} = -16 \text{ mA}$	4.5 V	3.8	, S	•	3.8			
	I <sub>OL</sub> = 50 μA	2 V to 5.5 V		,S	0.1			0.1	
	$I_{OL} = 2 \text{ mA}$	2.3 V		Q.	0.4			0.4	.,
$V_{OL}$	I <sub>OL</sub> = 8 mA	3 V		4	0.44			0.44	V
	I <sub>OL</sub> = 16 mA	4.5 V	770		0.55			0.55	
lį	V <sub>I</sub> = 5.5 V or GND	0 to 5.5 V	20		±1			±1	μΑ
IOZ	$V_O = V_{CC}$ or GND	5.5 V	Q.		±5			±5	μΑ
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			20			20	μΑ
I <sub>off</sub>	$V_{I}$ or $V_{O} = 0$ to 5.5 V	0			5			5	μΑ
Ci	V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V		2.3			2.3		pF



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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 2.5 V $\pm$ 0.2 V (unless otherwise noted) (see Figure 1)

DADAMETER	FROM	то	LOAD	T,	Δ = 25°C	;	SN54L	V240A	SN74L	V240A	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
<sup>t</sup> pd	А	Υ			6.3*	11.6*	1*	14*	1	14	
t <sub>en</sub>	ŌĒ	Υ	C <sub>L</sub> = 15 pF		8.5*	14.6*	1*	17*	1	17	ns
<sup>t</sup> dis	ŌĒ	Υ			9.7*	14.1*	1*	16*	1	16	
<sup>t</sup> pd	А	Υ			8.2	14.4	1	17	1	17	
t <sub>en</sub>	ŌĒ	Υ	0 50		10.3	17.8	$\eta_{Q}$	21	1	21	
t <sub>dis</sub>	ŌĒ	Υ	C <sub>L</sub> = 50 pF		14.2	19.2	0 V	21	1	21	ns
tsk(o)						2				2	

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

	FROM	то	LOAD	T,	Δ = 25°C	;	SN54L	V240A	SN74L	V240A	
PARAMETER	ETER (INPUT) (OUTPUT) CAPACITANCE		MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
<sup>t</sup> pd	А	Υ			4.6*	7.5*	1*	9*	1	9	
ten	ŌĒ	Υ	C <sub>L</sub> = 15 pF		6.2*	10.6*	1*	12.5*	1	12.5	ns
<sup>t</sup> dis	ŌĒ	Υ			8.3*	12.5*	1*	13.5*	1	13.5	
t <sub>pd</sub>	А	Υ			5.9	11	1	12.5	1	12.5	
t <sub>en</sub>	ŌĒ	Υ	0 50 5		7.5	14.1	770	16	1	16	
<sup>t</sup> dis	ŌĒ	Y	$C_L = 50 pF$		11.8	15	20 1	17	1	17	ns
t <sub>sk(o)</sub>						1.5				1.5	

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

	FROM	то	LOAD	T,	Δ = 25°C	;	SN54L\	/240A	SN74L	V240A	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
<sup>t</sup> pd	А	Υ			3.4*	5.5*	1*	6.5*	1	6.5	
ten	ŌĒ	Υ	C <sub>L</sub> = 15 pF		4.6*	7.3*	1*	8.5*	1	8.5	ns
<sup>t</sup> dis	ŌĒ	Υ			7.4*	12.2*	1*	13.5*	1	13.5	
t <sub>pd</sub>	А	Υ			4.4	7.5	1	8.5	1	8.5	
<sup>t</sup> en	ŌĒ	Υ	0 50		5.6	9.3	170	10.5	1	10.5	
<sup>t</sup> dis	ŌĒ	Υ	C <sub>L</sub> = 50 pF		9.7	14.2	Q 1	15.5	1	15.5	ns
<sup>t</sup> sk(o)						1				1	

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.



# SN54LV240A, SN74LV240A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS SCLS384H - SEPTEMBER 1997 - REVISED APRIL 2005

## noise characteristics, $V_{CC}$ = 3.3 V, $C_L$ = 50 pF, $T_A$ = 25°C (see Note 5)

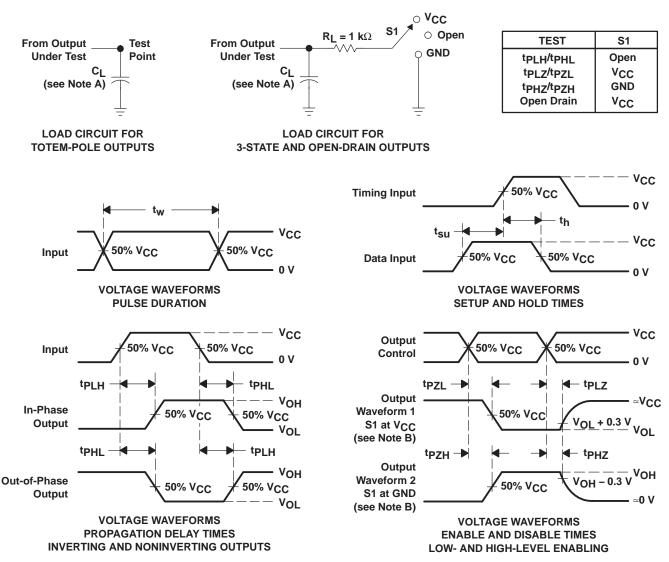
	DADAMETED	SN7			
	PARAMETER	MIN	TYP	MAX	UNIT
V <sub>OL(P)</sub>	Quiet output, maximum dynamic V <sub>OL</sub>		0.56		V
V <sub>OL(V)</sub>	Quiet output, minimum dynamic V <sub>OL</sub>		-0.49		V
VOH(V)	Quiet output, minimum dynamic VOH		2.82		V
VIH(D)	High-level dynamic input voltage	2.31			V
V <sub>IL(D)</sub>	Low-level dynamic input voltage			0.99	V

NOTE 5: Characteristics are for surface-mount packages only.

#### operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST COI	VCC	TYP	UNIT	
<u> </u>	Down discination conscitons	C. F0 pF	f = 10 MHz	3.3 V	14	pF
Cpd	Power dissipation capacitance	$C_L = 50 pF$ ,	f = 10 MHz	5 V	16.4	рг

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_Q = 50 \Omega$ ,  $t_f \leq$  3 ns,  $t_f \leq$  3 ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms







5-Sep-2005

#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74LV240ADBLE	OBSOLETE	SSOP	DB	20		TBD	Call TI	Call TI
SN74LV240ADBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240ADBRE4	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240ADGVR	ACTIVE	TVSOP	DGV	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240ADGVRE4	ACTIVE	TVSOP	DGV	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240ADWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240ADWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240ANSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240APW	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240APWE4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240APWLE	OBSOLETE	TSSOP	PW	20		TBD	Call TI	Call TI
SN74LV240APWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240APWRE4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240APWRG4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240APWT	ACTIVE	TSSOP	PW	20	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LV240APWTE4	ACTIVE	TSSOP	PW	20	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



#### PACKAGE OPTION ADDENDUM

5-Sep-2005

retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### DGV (R-PDSO-G\*\*)

#### **24 PINS SHOWN**

#### **PLASTIC SMALL-OUTLINE**



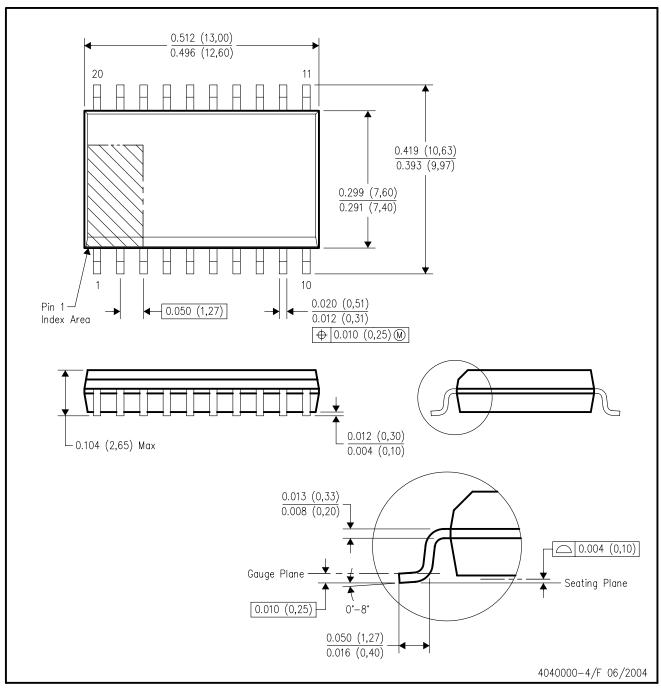
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153 14/16/20/56 Pins – MO-194



## DW (R-PDSO-G20)

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



#### **MECHANICAL DATA**

#### NS (R-PDSO-G\*\*)

#### 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- . All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



#### DB (R-PDSO-G\*\*)

#### **PLASTIC SMALL-OUTLINE**

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



#### PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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